



# Product Change Notification

**Change Notification #:** 116158 - 01  
**Change Title:** Intel® Server Chassis H2204XXLRE,  
Intel® Server Chassis H2216XXLR2,  
Intel® Server Chassis H2224XXLR2,  
Intel® Server Chassis H2224XXLR3,  
Intel® Server Chassis H2312XXLR2,  
Intel® Server Chassis H2312XXLR3,  
Intel® Server Power Supply  
FXX2130PCRPS,  
PCN 116158-01, Product Design, Label,  
Power supply 2130W firmware and label  
update,  
Reason for Revision: Update the TA of  
H2204XXLRE, add products affected, and  
update the firmware revision  
**Date of Publication:** June 18, 2019

## Key Characteristics of the Change:

Product Design, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	March 28, 2018
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

**Reason for Revision: Update the TA of H2204XXLRE, add products affected, and update the firmware revision**

Intel is implementing the following changes on the label of Intel® Server Power Supply FXX2130PCRPS. The change updates the Top Assembly number (TA) of Intel® Server Chassis listed in the table “Products Affected”.

List of changes:

1. Change the manufacturing site from SAMSUMG® to SoluM®
2. Replace the safety logo “CQC” to “CCC”
3. Update the number of the safety logos of BSMI, UL and KCC
4. The firmware of the Power Supply updates from 21.0.128 to 28.0.128 (MCU and FRU update).
  - a. Update the power supply product number from H66158-007 to H66158-008
  - b. Update the power supply revision number from 01A to 02A

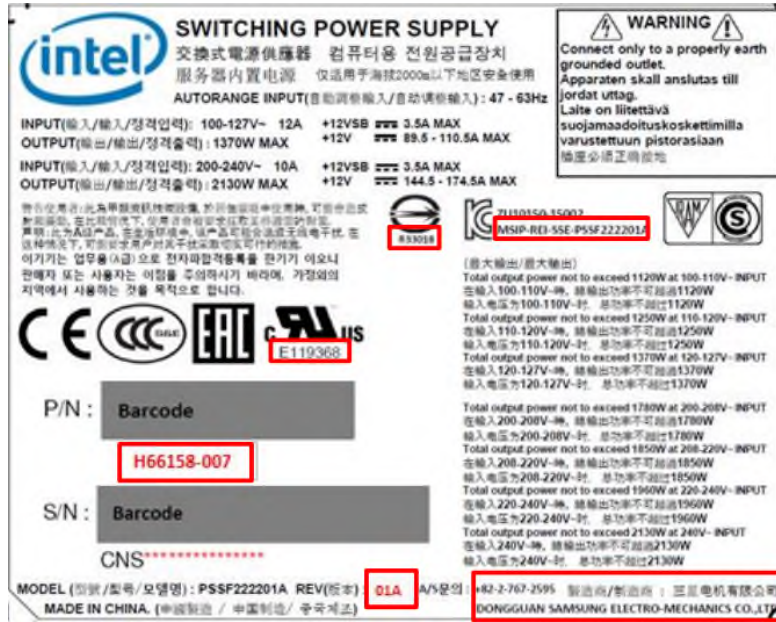


Image 1. PSU label before change

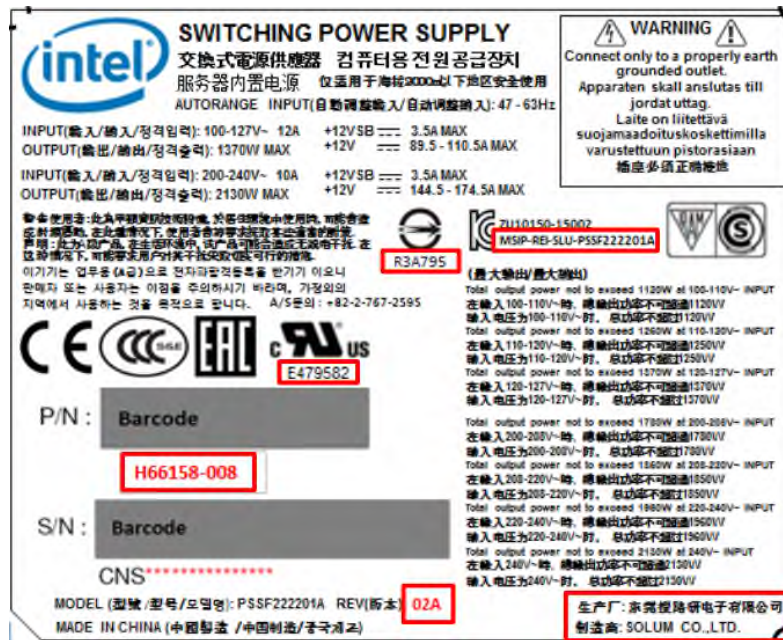


Image 2. PSU label after change

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre-Change TA#	Post- Change TA#
<a href="#">H2204XXLRE</a>	957322	<a href="#">J32925-007</a>	<a href="#">J32925-008</a>
<a href="#">H2216XXLR2</a>	942353	<a href="#">H95607-007</a>	<a href="#">H95607-008</a>
<a href="#">H2224XXLR2</a>	943577	<a href="#">H96144-006</a>	<a href="#">H96144-007</a>
<a href="#">H2312XXLR2</a>	942352	<a href="#">J17277-007</a>	<a href="#">J17277-008</a>
<a href="#">H2312XXLR3</a>	954487	<a href="#">J57869-002</a>	<a href="#">J57869-003</a>
<a href="#">H2224XXLR3</a>	948907	<a href="#">J57870-002</a>	<a href="#">J57870-003</a>
<a href="#">FXX2130PCRPS</a>	948196	<a href="#">J23209-003</a>	<a href="#">J23209-004</a>

## PCN Revision History:

**Date of Revision:**

March 13, 2018

[June 19, 2019](#)

**Revision Number:**

00

[01](#)

**Reason:**

Originally Published PCN

[Update the TA of H2204XXLRE, add products affected, and update the firmware revision](#)



# Product Change Notification

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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